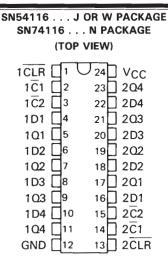
DECEMBER 1972-REVISED MARCH 1988

# **DUAL 4-BIT LATCHES WITH CLEAR**

Two Independent 4-Bit Latches in a Single Package

- Separate Clear Inputs Provide One-Step Clearing Operation
- **Dual Gated Enable Inputs Simplify Cascad**ing Register Implementations
- Compatible for Use with TTL Circuits
- Input Clamping Diodes Simplify System Design



#### description

These monolithic TTL circuits utlize D-type bistables to implement two independent four-bit latches in a single package. Each four-bit latch has an independent asynchronous clear input and a gated two-input enable circuit. When both enable inputs are low, the output levels will follow the data input levels. When either or both of the enable inputs are taken high, the outputs remain at the last levels setup at the inputs prior to the low-to-high-level transition at the enable input(s). After this, the data inputs are locked out.

The clear input is overriding and when taken low will reset all four outputs low regardless of the levels of the enable inputs.

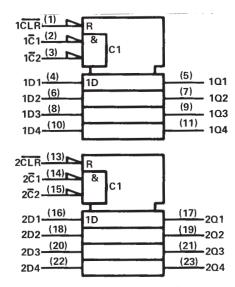
The SN54116 is characterized for operation over the full military temperature range of -55°C to 125°C; the SN74116 is characterized for operation from 0°C to 70°C.

**FUNCTION TABLE** (EACH LATCH)

	INPUTS								
CLEAR	ENA	BLE	DATA	OUTPUT					
CLEAR	Ĉ1	C2	DATA						
Н	L	L	L	L					
н	L	L	н	н					
н	×	Н	×	α <sub>0</sub>					
н	н	X	×	α <sub>0</sub>					
L	X	X	×	L					

H = high level, L = low level, X = irrelevant

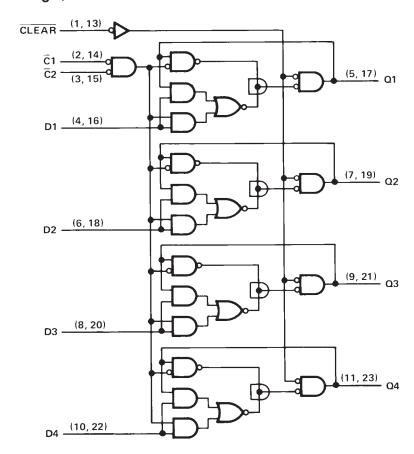
## logic symbol†



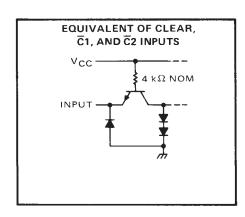
<sup>&</sup>lt;sup>†</sup>This symbol is in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

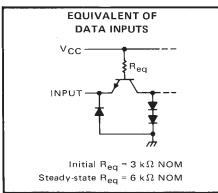
 $Q_0$  = the level of Q before these input conditions were established.

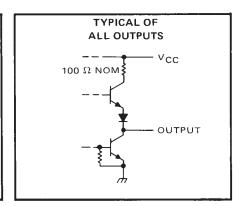
### logic diagram (positive logic)



#### schematics of inputs and outputs







#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1) .		 						7 V
Input voltage		 						5.5 V
Operating free-air temperature range:	SN54116 Circuits							$-55^{\circ}$ C to $125^{\circ}$ C
	SN74116 Circuits							. 0°C to 70°C
Storage temperature range		 						$-65^{\circ}$ C to $150^{\circ}$ C

NOTE 1: Voltage values are with respect to network ground terminal.



### recommended operating conditions

			SN5411	6	- ;			
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V <sub>CC</sub>			5	5.5	4.75	5	5.25	V
High-level output current, IOH				-800			-800	μΑ
Low-level output current, IOL				16			16	mA
Annua mula midala a	<u>C</u> 1, <u>C</u> 2	18	_		18			
Input pulse width, t <sub>W</sub>	CLR	18			18			ns
Date cation time. A	High logic level	8			8			
Data setup time, t <sub>su</sub>	Low logic level	14			14			ns
Clear inactive-state setup time, t <sub>su</sub>		8			8			ns
Data release time, high-level data, t <sub>release</sub>				2			2	
Data hold time, low-level data, th		8			8.			ns
Operating free-air temperature, TA		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER		TEST CON	IDITIONS†	MIN	TYP‡	MAX	UNIT
VIH	High-level input voltage				2			V
VIL	Low-level input voltage						0.8	٧
VIK	Input clamp voltage		V <sub>CC</sub> = MIN,	I <sub>I</sub> = -12 mA			-1.5	V
Vон	High-level output voltage		V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V,	V <sub>IH</sub> = 2 V, I <sub>OH</sub> = -800 μA	2.4	3.4		V
VOL	Low-level output voltage		V <sub>CC</sub> = MIN, V <sub>IL</sub> = 0.8 V,			0.2	0.4	٧
կ	Input current at maximum input voltage		V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5 V			1	mA
	High total input groups	C1, C2, or clear	V <sub>CC</sub> = MAX,			40	μΑ	
ΉΗ	High-level input current	Any D	VCC - WAA,	V   - 2.4 V			60	μΑ
		C1, C2, or clear					-1.6	
HE	Low-level input current	Any D, initial peak	$V_{CC} = MAX,$	V <sub>I</sub> = 0.4 V			-2.4	mA
		Any D, steady-state					-1.6	
	8		V <sub>CC</sub> = MAX	SN54116	-20		-57	^
los	Short-circuit output current §	currents		SN74116	-18		<b>-57</b>	mA
			V <sub>CC</sub> = MAX,	Condition A		60	100	mA
ICC	Supply current		See Note 2		40	70	""	

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable device

NOTE 2: With outputs open,  $I_{\hbox{\footnotesize{CC}}}$  is measured for the following conditions:

A. All inputs grounded.

### switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25^{\circ} \text{ C}$

	FROM	TO					
PARAMETER	(INPUT)	(OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH		A O			19	30	
t <sub>PHL</sub>	CT or C2	Any Q	Cլ = 15 pF,		15	22	ns
t <sub>PLH</sub>	D-1-	0	$R_L = 400 \Omega$ ,		10	15	
tPHL.	Data	Q	See Figure 1		12	18	ns
tPHL.	CLR	Any Q			15	22	ns

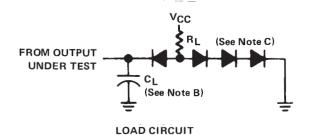


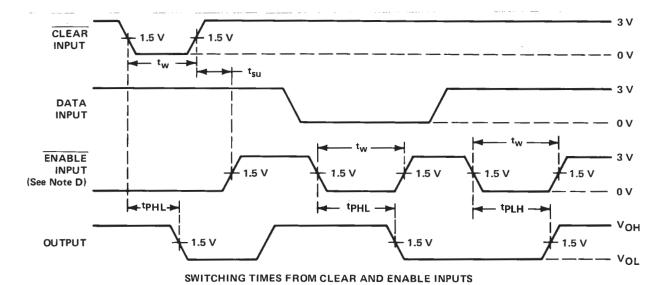
 $<sup>^{\</sup>ddagger}$ All typical values are at  $V_{CC}$  = 5 V,  $T_{A}$  = 25°C.

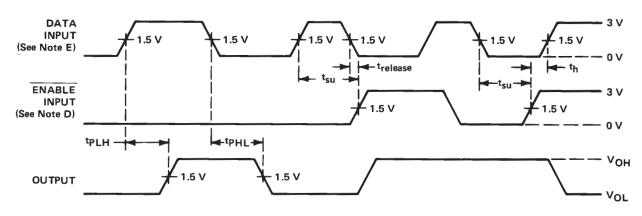
<sup>§</sup> Not more than one output should be shorted at a time.

B. All  $\overline{C}$  inputs are grounded and all other inputs are at 4.5 V.

#### PARAMETER MEASUREMENT INFORMATION







SWITCHING TIMES FROM DATA INPUTS

NOTES: A. Input pulses are supplied by generators having the following characteristics:  $t_r \le 10$  ns,  $t_f \le 10$  ns, PRR = 1 MHz, duty cycle  $\le 50\%$ ,  $Z_{OUT} \approx 50\Omega$ .

- B. C<sub>L</sub> includes probe and jig capacitance.
- C. All diodes are 1N3064 or equivalent.
- D. The other enable input is low.
- E. Clear input is high.

FIGURE 1



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